



a first process of placing a surface of said material to be marked and a surface of said marking material together with a desired gap therebetween, vaporizing said marking material by irradiating through said material to be marked with a first laser beam while scanning with the first laser beam, and depositing a deposit vaporized from said marking material onto a predetermined portion of said material to be marked; and

 a second process of removing a part of said deposit deposited onto the surface of said material to be marked by irradiating the part of the deposit with a second laser beam while scanning with the second laser beam;

wherein patterns of characters, diagrams or symbols are formed on said material to be marked; and

 wherein said desired gap is between $2\mu\text{m}$ and $200\mu\text{m}$.
